Description

The 5L1503 is a series of small form factor programmable clock generators intended for low-power, consumer, battery powered applications, wearable and smart devices.

The device is a 1 PLL + DCO architecture design with an external fundamental crystal or clock input. The device allows up to 3 unique frequency outputs. The 5L1503 has built-in unique features such as Proactive Power Saving (PPS) and an extreme low power DCO to support system date/time keeping clock at 32.768kHz. Dynamic Frequency Control (DFC) supports dynamically changing between four different PLL frequencies via external requests with controlled frequency changes, reducing frequency overshoot and undershoot (ORT). The 5L1503S device can also support a spread clock output for EMI reduction. For a description of terms and their functions, see Glossary of Features.

An internal OTP memory allows the user to store up to four independent configurations that can be loaded on power-up without programming.

The 5L1503 supports three LVCMOS type outputs with VDDO1.8V, as well as various amplitude clocks. A low-power 32.768kHz clock is supported with only less than 1µA current consumption for system RTC reference clock needs.

5L1503 Base Number	Description	VCO Range (MHz)
5L1503	Standard, External Crystal	50 – 130
5L1503L	Ultra Low-power, External Crystal	50 – 130
5L1503S	Spread Clock, External Crystal	500 –1100

Typical Applications

- SmartDevice
- Handheld
- Wearable applications
- Portable Consumer applications

Features

- Proactive Power Saving (PPS) features save power during the end device power-down mode
- Dynamic Frequency Control (DFC) feature allows programming up to 4 difference frequencies that switch dynamically
- Multiple output clock amplitude (1V, 1.1V, 1.2V and 1.8V) to support low swing clock requirement
- Dedicated 32kHz output with 6 clock amplitude options (5L1503L)
- Configurable through OTP programming
- Spread spectrum clock support (5L1503S)
- 1.8V operating supply voltage
- 2 × 2 mm 10-VFQFPN package

Output Features

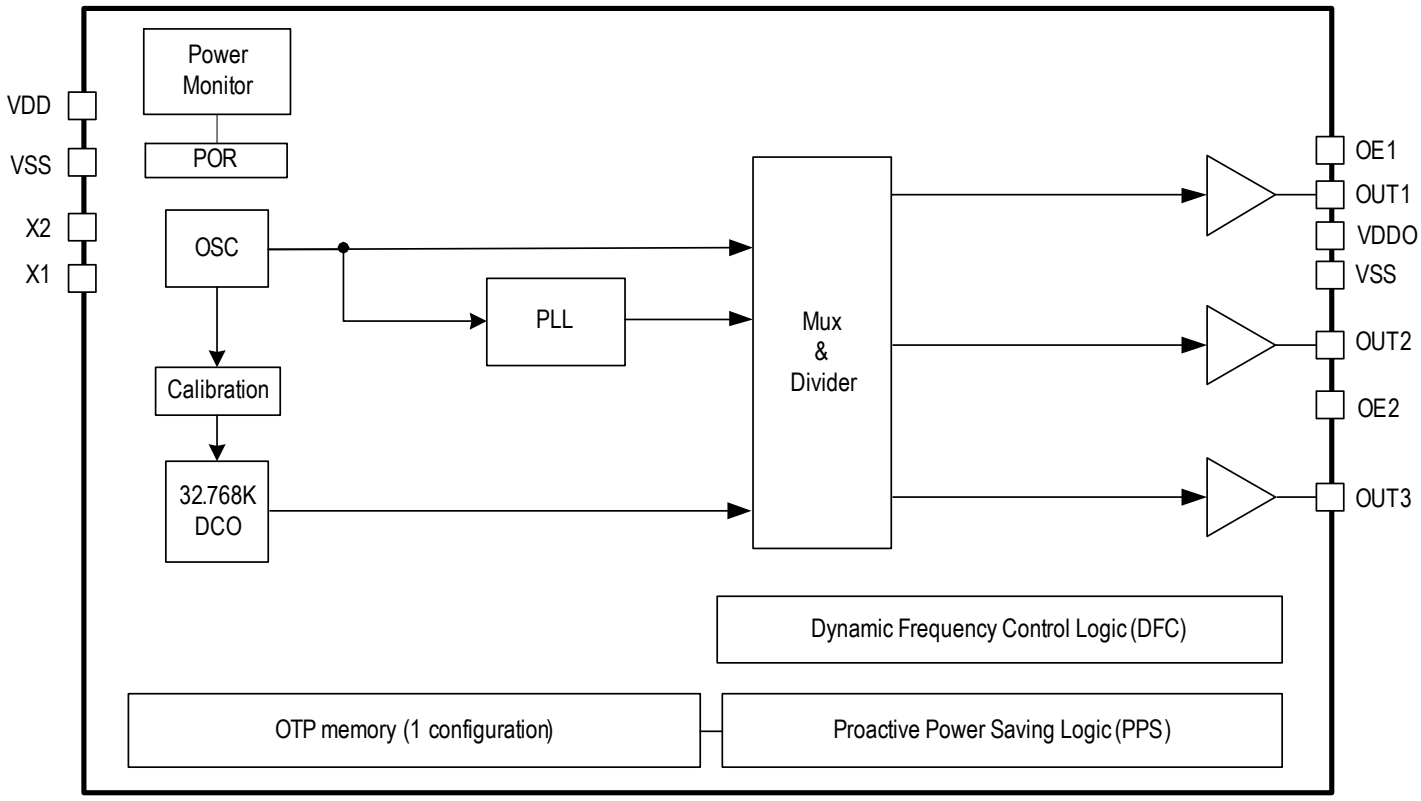
- 3 LVCMOS outputs, 1MHz–100MHz or 32.768kHz
- Low-power 32.768kHz clock supported

Key Specifications

- Output cycle-cycle jitter: 50ps (typ)
- Low power-on fully active mode: 2mA (typ)
- Low-power 32.768kHz < 1.0µA (5L1503L)

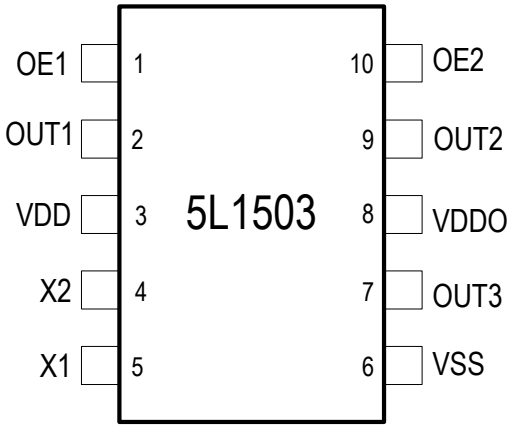
Contents

Block Diagram



Pin Assignments

Figure 1. Pin Assignments for 2.0 × 2.0 mm 10-VFQFPN Package



Pin Descriptions

Table 1. Pin Descriptions

Number	Name	Type	Description
1	OE1	Input	OUT1 Output Enable Pin. The pin can be configured to other functions (DFC and PPS) refer to OE Pin Function table.
2	OUT1	Output	Programmable LVCMOS clock output (32.768kHz only on 5L1503L).
3	VDD	Power	1.8V power supply for core, PLL and 32kHZ DCO.
4	X2	Output	Crystal oscillator interface output.
5	X1/CLKIN	Input	Crystal oscillator interface input or single-ended LVCMOS clock input.
6	VSS	GND	Connect to ground.
7	OUT3	Output	Programmable LVCMOS clock output.
8	VDDO	Power	1.8V power supply for I/O.
9	OE2	Input	OUT2 output enable pin. The pin can be configured to other functions (DFC, PPS).
10	OUT2	Output	Programmable LVCMOS clock output.

Device Feature and Function

DFC – Dynamic Frequency Control

- OTP programmable–4 different feedback fractional dividers (4 VCO frequencies) that apply to PLL.
- ORT (overshoot reduction) function will be applied automatically during the VCO frequency change.
- Smooth frequency incremental or decremental from current VCO to targeted VCO based on DFC hardware pins selection.

Figure 2. DFC Function Block Diagram

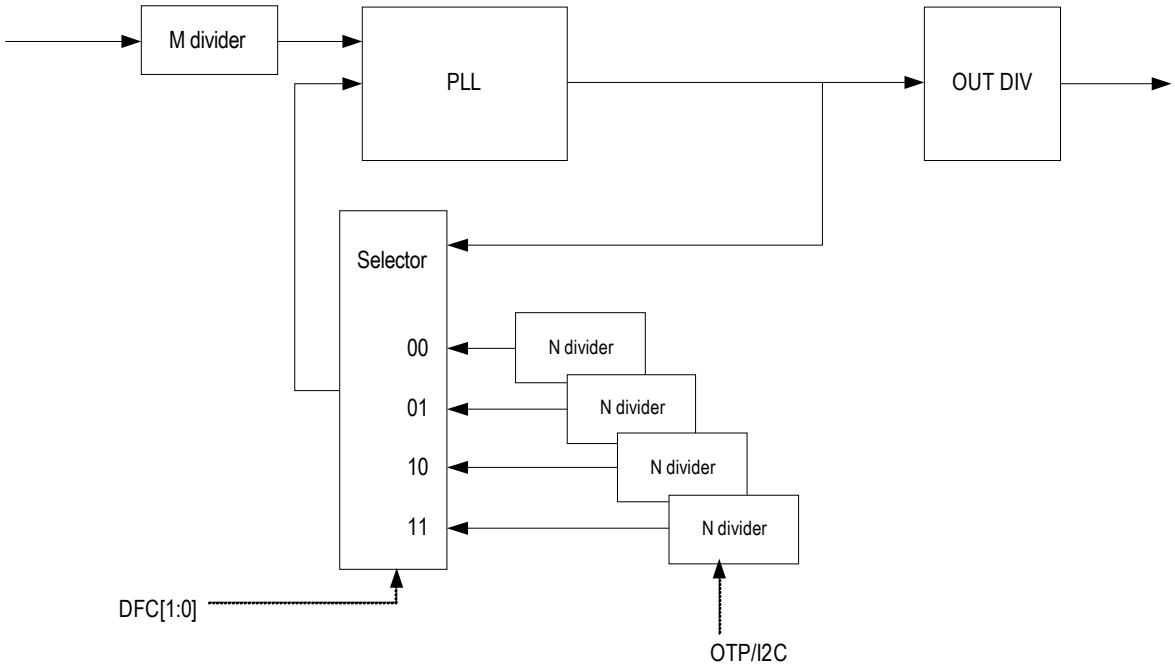


Table 2. DFC Function Priority

Mode	DFC_EN B17[0]	SCL_HW_Mode_sel B18[5]	OE1_fun_sel B16[6:5]	OE2_fun_sel B16[3:2]	Config	DFC1	DFC0	Notes
x	0	x	x	x	x	x	x	DFC disable.
HW	1	1	11	11	OTP	OE2	OE1	Select via pins.
HW	1	1	11	01	OE2	—	OE1	Select via single pin.

DFC Function Programming

- Register B0b1:0 – select DFC00–DFC11 configuration.
- Byte5–8 are the registers for PLL VCO setting. Based on B0b1:0 configuration selection, the data write to B5–8 will be stored in selected configuration OTP memory.
- Refer to DFC Function Priority table. Select proper control pin(s) to activate DFC function.

PPS – Proactive Power Saving Function

PPS (Proactive Power Saving) is an IDT patented unique design for the clock generator that proactively detects end device power down state and then switches output clocks between normal operation clock frequency and low power mode 32kHz clock that only consumes < 1.5µA current. The system could save power when the device goes into power down or sleep mode. The PPS function diagram is shown as below.

Figure 3. PPS Function Block Diagram

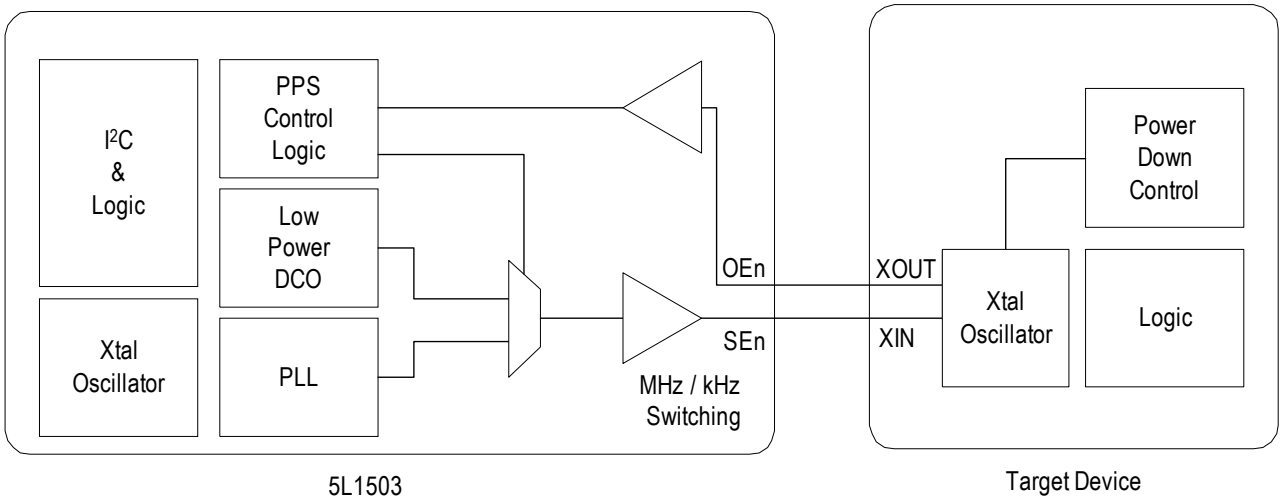
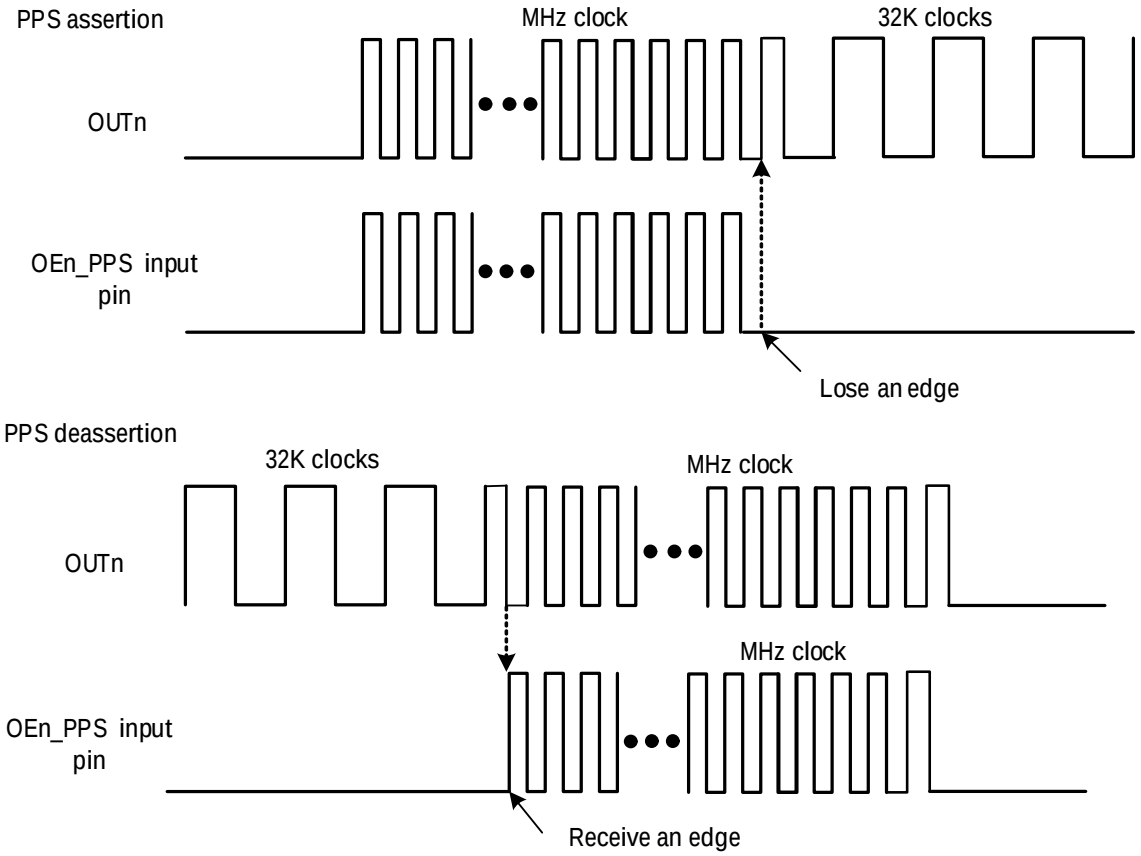


Figure 4. PPS Assertion/Deassertion Timing Chart



PPS Function Programming

- Refer to the OE Pin Function table to have proper PPS function selected for OE pin(s). Note that the register default is set to Output Enable (OE) function for OE pins.
- Have proper setup to Byte 16 for OE1–OE2 function selection. For PPS function, select 10 to control register bits.

Output Divider Selection

Table 3. Output Divider Selection

Output Divider bits<4:3>	Output Divider bits<2:0>					
	000	001	010	011	100	101
00	1	3	5	7	9	11
01	2	6	10	14	18	22
10	4	12	20	28	36	44
11	8	24	40	56	72	88

Device Output Support

5L1503

Outputs	Frequency	Amplitude	VCO Range	Spread Spectrum
OUT1	32kHz or up to 100MHz LVCMOS	1.8V	50MHz – 130MHz	N/A
OUT2		1V, 1.1V, 1.2V, 1.8V		
OUT3				

5L1503L

Outputs	Frequency	Amplitude	VCO Range	Spread Spectrum
OUT1	32kHz	0.8V, 0.9V, 1V, 1.1V, 1.2V, 1.8V	50MHz – 130MHz	N/A
OUT2	32kHz or up to 100MHz LVCMOS	1V, 1.1V,1.2V,1.8V		
OUT3				

5L1503S

Outputs	Frequency	Amplitude	VCO Range	Spread Spectrum
OUT1	32kHz or up to 100MHz LVCMOS	1.8V	500MHz – 1100MHz	Available
OUT2		1V, 1.1V, 1.2V, 1.8V		
OUT3				

OE Pin Function

OE pins in the 5L1503 have multiple functions. The OE pins can be configured as output enable control (OE) or chip power-down control (PD#) or Proactive Power Saving function (PPS). Furthermore, the OE pins can be configured as single or Dynamic Frequency Control (DFC).

Table 4. OE Pin Function

Function	OE1		OE2	
	B16<6:5>	Function	B16<3:2>	Function
SE Output Enable/Disable	00	OUT1 (Default)	00	OUT2 (Default)
Global Power Down (PD#)	01	PD#	01	Config_SEL
Proactive Power Saving Input	10	OUT1_PPS	10	OUT2_PPS
DFC Control	11	DFC0	11	DFC1

Note: Config_SEL and DFC Control require the device to be in H/W mode with no I2C access.

Table 5. OE Pin Function Summary

Pin	Function
OE1: OUT1	OE1 only control OUT1 enable/disable, other outputs are not affected by this pin status.
OE2: OUT2	OE2 only control OUT2 enable/disable, other outputs are not affected by this pin status.
OE1: PD#	OE1 control chip global power down (PD#) except 32.768kHz on OE1 (when 32K is enabled), When the PD# pin is active low, the chip goes to lowest power down mode and all outputs are disabled except 32kHz output, and only keeps 32k/Xtal calibration.
OE1: OUT1_PPS	Config OE1 as OUT1_PPS (Proactive Power Saving) function pin.
OE2: OUT2_PPS	Config OE2 as OUT2_PPS (Proactive Power Saving) function pin.
OE1:DFC0	Config OE1 as DFC0 control pin 0.
OE2:DFC1	Config OE2 as DFC1 control pin 1.

Table 6. PD# Priority

PD#	I2C_OE_EN_bit	OUT1/2/3, OUTx_PPS	Output	Notes
0	x	x	stop	32kHz free run
1	0	x	stop	
1	1	0	stop	
1	1	1	running	

Spread Spectrum

Spread Spectrum

The 5L1503 supports spread spectrum clocks from PLL with digital spread spectrum.

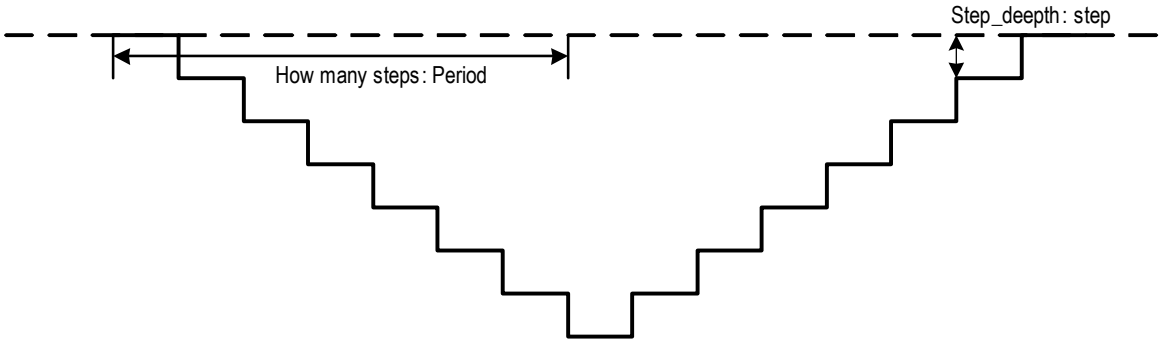
Digital Spread Spectrum

Figure 5. Digital Spread Spectrum

$$N = \frac{Fvco}{2 * Fout}$$

$$period = \frac{Fpfd}{2 * Fss}$$

$$step = \frac{N * SSamount}{period}$$



Down spread or spread off

N = Fvco/Fpfd
N: include integer and fraction
Fvco: VCOs frequency
Fpfd: PLLs pfd frequency
Fss: spread modulation rate
SSamount: spread percentage

N will decrease to make the center frequency lower than spread off.

Example: 0.5% down spread at 32kHz modulation rate.

Reference Input and Selection

The 5L1503 accepts an 8MHz–40MHz crystal input or 1MHz–100MHz LVCMOS (to X1) input. See the Crystal Oscillator Reference Circuit for details.

Crystal Input (X1/X2)

The crystal oscillators should be fundamental mode quartz crystals; overtone crystals are not suitable. Crystal frequency should be specified for parallel resonance with 54MHz maximum.

A crystal manufacturer will calibrate its crystals to the nominal frequency with a certain load capacitance value. When the oscillator load capacitance matches the crystal load capacitance, the oscillation frequency will be accurate as 0 PPM. When the oscillator load capacitance is lower than the crystal load capacitance, the oscillation frequency will be higher than nominal.

In order to get an accurate oscillation frequency, the matching the oscillator load capacitance with the crystal load capacitance is required.

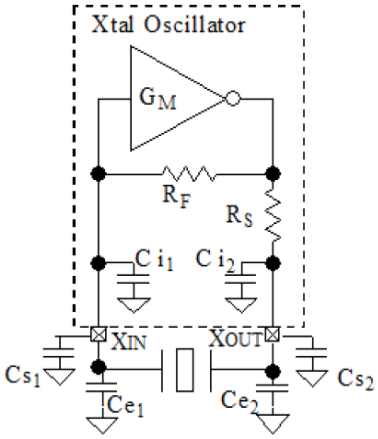
To set the oscillator load capacitance, 5L1503 has built-in two programmable tuning capacitors inside the chip, one at XIN and one at XOUT. They can not be adjusted independently, The value of each capacitor is composed of a fixed capacitance amount plus a variable capacitance amount set with the XTAL_CAP[3:0] register.

Adjustment of the crystal tuning capacitors allows for maximum flexibility to accommodate crystals from various manufacturers. The approximate range of tuning capacitor values available are in accordance with the following table.

Table 7. Programmable Tuning Capacitors

Parameter	Bits	Range	Minimum (pF)	Maximum (pF)
XTAL [3:0]	4 × 2	+1 / +2 / +4 / +8 pF	0	15

Figure 6. Crystal Oscillator Reference Circuit



XTAL[4:0] = (XTAL CL - 7pF) × 2 (Eq.1)

Equation 1 and the Programmable Tuning Capacitors table show that the parallel tuning capacitance can be set between 4.5pF to 12.5pF with a resolution of 0.25 pF.

For a crystal C_L= 8pF, where C_L is the parallel capacity specified by the crystal vendor that sets the crystal frequency to the nominal value. Under the assumptions that the stray capacity between the crystal leads on the circuit board is zero and that no external tuning caps are placed on the crystal leads, then the internal parallel tuning capacity is equal to the load capacity presented to the crystal by the device.

The internal load capacitors are true parallel-plate capacitors for ultra-linear performance. Parallel-plate capacitors were chosen to reduce the frequency shift that occurs when non-linear load capacitance interacts with load, bias, supply, and temperature changes. External non-linear crystal load capacitors should not be used for applications that are sensitive to absolute frequency requirements.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the 5L1503. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Table 8. Absolute Maximum Ratings

Item	Rating
Supply Voltage: V_{DD}, V_{DDO}	-0.5V – 2.2V
Inputs; DFC, OE1, OE2, SCL	-0.5V to V_{DD}/V_{DDO}
Outputs: LVCMOS	-0.5V to V_{DD}/V_{DDO} + 0.5V
Outputs: SDA	10mA
Storage Temperature, T_{STG}	-65°C to 150°C
ESD Human Body Model	2000V
Junction Temperature	125°C

Thermal Characteristics

Table 9. Thermal Characteristics

Symbol	Parameter	Value	Units
θ_{Jb}	Theta J_B. Junction to board	23.6	°C/W
θ_{JC}	Theta J_C. Junction to case	185.3	°C/W
	Moisture Sensitivity Rating (per J-STD-020)	MSL1	—

Recommended Operating Conditions

Table 10. Recommended Operating Conditions

Symbol	Parameter	Minimum	Typical	Maximum	Units
V_{DD}	Power Supply Voltage	1.71	—	1.89	V
V_{DDO}	Power Supply Voltage	1.71	—	1.89	V
T_A	Ambient Operating Temperature	-40	—	85	°C
C_{LOAD_OUT}	Maximum Load Capacitance (1.8V LVCMOS only)	—	2	—	pF
t_{PU}	Power-up Time for all V_{DD}s to reach Minimum Specified Voltage (power ramps must be monotonic)	0.05	—	3	ms

Crystal Characteristics

Table 11. Crystal Characteristics

Parameter	Test Conditions	Minimum	Typical	Maximum	Units
Mode of Oscillation	—	Fundamental			
Frequency	—	8	—	40	MHz
Frequency Tolerance [1]	—	—	—	±20	ppm
Equivalent Series Resistance (ESR)	—	—	10	80	Ω
Shunt Capacitance	—	—	2	7	pF
Load Capacitance (C_L)	—	6	8	10	pF
Maximum Crystal Drive Level	—	—	—	100	µW

[1] Frequency tolerance includes initial frequency, over temperature range and aging data.

[2] High Drive only when crystal frequency is higher than 30MHz.

DC Electrical Characteristics

Table 12. DC Electrical Characteristics – Current

V_{DD} = V_{DDO} = 1.8V ±5%, V_{SS} = 0V, T_A = -40°C to +85°C.

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
Idd	Core Supply Current (5L1503/5L1503L)	V_{DD} = V_{DDO} = 1.8V, Xtal = 54MHz, DCO = OFF, no output; PLL default.	—	—	2.0	mA
	Core Supply Current (5L1503S)	V_{DD} = V_{DDO} = 1.8V, Xtal = 54MHz, DCO = OFF, no output; PLL default.	—	—	9.5	mA
Idd_PLL	PLL Supply Current (5L1503/5L1503L)	V_{DD} = V_{DDO} = 1.8V, Xtal = 54MHz, no output; PLL= default	—	—	1.0	mA
	PLL Supply Current (5L1503S)	V_{DD} = V_{DDO} = 1.8V, Xtal = 54MHz, no output; PLL= default	—	—	9.0	mA
Iddox	Output Buffer Supply Current (5L1503/5L1503L)	LVCMOS, OUT1 = 8MHz, V_{DD} = V_{DDO} = 1.8V.	—	—	0.5	mA
		LVCMOS, OUT1 = 100MHz, V_{DD} = V_{DDO} = 1.8V.	—	—	2	mA
	Output Buffer Supply Current (5L1503S)	LVCMOS, OUT1 = 8MHz, V_{DD} = V_{DDO} = 1.8V.	—	—	0.5	mA
		LVCMOS, OUT1 = 100MHz, V_{DD} = V_{DDO} = 1.8V.	—	—	2	mA
Iddpd	Power Down Current (5L1503/5L1503L)	PD asserted with V_{DD} and V_{DDO} ON, I2C enable, 32.768kHz clock running.	—	—	310	µA
	Power Down Current (5L1503S)	PD asserted with V_{DD} and V_{DDO} ON, I2C enable, 32.768kHz clock running.	—	—	320	µA
Iddupd	Ultra Power Down Current (5L1503/5L1503L)	PD asserted with V_{DD} and V_{DDO} ON, I2C disable, 32.768kHz clock running.	—	—	7	µA
	Ultra Power Down Current (5L1503S)	PD asserted with V_{DD} and V_{DDO} ON, I2C disable, 32.768kHz clock running.	—	—	9.5	µA

Table 12. DC Electrical Characteristics – Current (Cont.)

V_{DD} = V_{DDO} = 1.8V ±5%, V_{SS} = 0V, T_A = -40°C to +85°C.

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
Iddsuspend	Power Suspend Current (5L1503)	V_{DDD} = 1.8V, V_{DDO} = GND, OUT1 = 32.768kHz running in DCO mode, no output loads, I2C and OE pins open.	—	—	1.4	µA
	Power Suspend Current (5L1503L)	V_{DDD} = 1.8V, V_{DDO} = GND, OUT1 = 32.768kHz running in DCO mode, no output loads, I2C and OE pins open.	—	—	1	µA
	Power Suspend Current (5L1503S)	V_{DDD} = 1.8V, V_{DDO} = GND, OUT1 = 32.768kHz running in DCO mode, no output loads, I2C and OE pins open.	—	—	1.4	µA

Table 13. DC Electrical Characteristics – Input and Output Voltage

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
V_{OH}	Output High Voltage	I_{OH} = -8mA.	0.7 × V_{DDO}	—	V_{DDO}	V
V_{OL}	Output Low Voltage	I_{OL} = 8mA.	—	—	0.25 × V_{DDO}	V
I_{OZDD}	Output Leakage Current	Tri-state outputs, V_{DDO} = 1.89V.	—	—	80	µA
V_{IH}	Input High Voltage	Single-ended inputs – OE.	0.65 × V_{DDO}	—	V_{DDO} + 0.3	V
V_{IL}	Input Low Voltage	Single-ended inputs – OE.	GND - 0.3	—	0.35 × V_{DDO}	V

AC Electrical Characteristics

Table 14. AC Timing Electrical Characteristics

V_{DDSE}= 1.8V ±5%, T_A = -40°C to +85°C. Spread spectrum = OFF.

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
f_{IN}	Xtal Frequency Range	Input frequency limit (XIN)[1].	8	—	40	MHz
	Clock In	Input frequency limit (Clock In).	1	—	100	MHz
f_{OUT}	Output Frequency	Single-ended clock output limit (LVCMOS).	1	—	100	MHz
f_{VCO1}	VCO Frequency Range of PLL	VCO operating frequency range (5L1503).	50	—	130	MHz
f_{VCO2}	VCO Frequency Range of PLL	VCO operating frequency range (5L1503L).	50	—	130	MHz
f_{VCO3}	VCO Frequency Range of PLL	VCO operating frequency range (5L1503S).	500	—	1100	MHz
f_{PFD1}	PFD Frequency Range of PLL1	PFD operating frequency range (5L1503 and 5L1503L).	0	—	13	MHz
f_{PFD1}	PFD Frequency Range of PLL1	PFD operating frequency range(5L1503S).	0.8	—	100	MHz
f_{BW1}	Loop Bandwidth for PLL1	Input frequency = TBD.	0.001	—	1	MHz
F_{32K_ACC1}	32K Stability	Average accuracy after 24 hours[2].	—	—	42	ppm
F_{32K_ACC2}	32K Stability	Average accuracy after 3 days[2].	—	—	36	ppm

Table 14. AC Timing Electrical Characteristics (Cont.)

V_{DDSE}= 1.8V ±5%, T_A = -40°C to +85°C. Spread spectrum = OFF.

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
F_{32K_ACC3}	32K Stability	Average accuracy after 7 days[2].	—	—	32	ppm
	Minimum Input Amplitude	For a 40/60% SE input duty cycle.	800	—	V_{DD}	mV
t2	Input Duty Cycle	Duty cycle.	30	—	70	%
t3	Output Duty Cycle	Measured at V_{DD}/2, all outputs with a crystal or a 50% input duty cycle clock.	45	—	55	%
t4[3]	Rise/Fall Slew Rate	1.8V LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD} (output load = 2pF).	—	2.0	—	V/ns
t4[3]	Rise/Fall Slew Rate	1.2V LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD} (output load = 2pF).	—	1.1	—	V/ns
t4[3]	Rise/Fall Slew Rate	1.1V LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD} (output load = 2pF).	—	1.0	—	V/ns
t4[3]	Rise/Fall Slew Rate	1.0V LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD} (output load = 2pF).	—	1.0	—	V/ns
t4	Rise/Fall Slew	OUT1 1.8V 32kHz LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD}, Byte20<2:0> = x0 (5X1503L).	—	27.4	—	V/µs
t4	Rise/Fall Slew	OUT1 0.8V 32kHz LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD}, Byte20<2:0> = x1 (5X1503L).	—	2.3	—	V/µs
t4	Rise/Fall Slew	OUT1 0.9V 32kHz LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD}, Byte20<2:0> = x2 (5X1503L).	—	3.9	—	V/µs
t4	Rise/Fall Slew	OUT1 1.0V 32kHz LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD}, Byte20<2:0> = x3 (5X1503L).	—	5.4	—	V/µs
t4	Rise/Fall Slew	OUT1 1.1V 32kHz LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD}, Byte20<2:0> = x4 (5X1503L).	—	6.7	—	V/µs
t4	Rise/Fall Slew	OUT1 1.2V 32kHz LVCMOS clock rise and fall time, 20% to 80% of V_{DDO}/V_{DD}, Byte20<2:0> = x5 (5X1503L).	—	8.5	—	V/µs
t6[4]	Clock Jitter	Cycle-to-cycle jitter, 1.8V LVCMOS output clock. OUT1 = 32.768kHz (1.8V LVCMOS) OUT2 = 72MHz OUT3 = 26MHz	—	50	—	ps

Table 14. AC Timing Electrical Characteristics (Cont.)

V_{DDSE}= 1.8V ±5%, T_A = -40°C to +85°C. Spread spectrum = OFF.

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
t6[4]	Clock Jitter	Cycle-to-cycle jitter, 1.2V LVCMOS output clock. SOUT1 = 32.768kHz (1.8V LVCMOS) OUT2 = 72MHz OUT3 = 26MHz	—	50	—	ps
t6[4]	Clock Jitter	Cycle-to-cycle jitter, 1.1V LVCMOS output clock. OUT1 = 32.768kHz (1.8V LVCMOS) OUT2 = 72MHz OUT3 = 26MHz	—	50	—	ps
t6[4]	Clock Jitter	Cycle-to-cycle jitter, 1.0V LVCMOS output clock. OUT1 = 32.768kHz (1.8V LVCMOS) OUT2 = 72MHz OUT3 = 26MHz	—	50	—	ps
t7	Output Skew	Skew between the same frequencies, with outputs using the same driver format.	—		300	ps
t8[5]	Lock Time	PLL lock time from power-up.	—		5	ms
t9	Lock Time	32.768kHz clock low power power-up time.	—	10	20	ms
t9[6]	Lock Time	PLL lock time from shutdown mode.	—	0.5	1	ms

[1] High Drive only when Crystal Frequency is higher than 30MHz.

[2] The data is measured on constant temperature.

[3] The slew rate is set by Byte19<3:2> and Byte19<1:0>.

[4] Jitter performance depend on output configuration.

[5] Includes loading the configuration bits from EPROM to PLL registers. It does not include EPROM programming/write time.

[6] Actual PLL lock time depends on the loop configuration.

I²C Bus DC Characteristics

Table 15. I²C Bus DC Characteristics

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Level	—	0.7 × V_{DDO}	—	—	V
V_{IL}	Input Low Level	—	—	—	0.3 × V_{DDO}	V
V_{HYS}	Hysteresis of Inputs	—	0.05 × V_{DDO}	—	—	V
I_{IN}	Input Leakage Current	—	—	1	10	µA
V_{OL}	Output Low Voltage	I_{OL} = 3mA.	—	—	0.4	V

Note: I2C bus is 3.3V tolerant.

Table 16. I^2C Bus AC Characteristics

Symbol	Parameter	Minimum	Typical	Maximum	Units
F_{SCLK}	Serial Clock Frequency (SCL)	0	—	400	kHz
t_{BUF}	Bus Free Time between STOP and START	1.3	—	—	µs
$t_{SU:START}$	Setup Time, START	0.6	—	—	µs
$t_{HD:START}$	Hold Time, START	0.6	—	—	µs
$t_{SU:DATA}$	Setup Time, Data Input (SDA)	100	—	—	ns
$t_{HD:DATA}$	Hold Time, Data Input (SDA) [1]	0	—	—	µs
t_{OVD}	Output Data Valid from Clock	—	—	0.9	µs
C_B	Capacitive Load for Each Bus Line	—	—	400	pF
t_R	Rise Time, Data and Clock (SDA, SCL)	$20 + 0.1 \times C_B$	—	300	ns
t_F	Fall Time, Data and Clock (SDA, SCL)	$20 + 0.1 \times C_B$	—	300	ns
t_{HIGH}	High Time, Clock (SCL)	0.6	—	—	µs
t_{LOW}	Low Time, Clock (SCL)	1.3	—	—	µs
$t_{SU:STOP}$	Setup Time, STOP	0.6	—	—	µs

[1] A device must internally provide a hold time of at least 300ns for the SDA signal (referred to the $V_{IH(MIN)}$ of the SCL signal) to bridge the undefined region of the falling edge of SCL.

Spread Spectrum Generation Specifications

Table 17. Spread Spectrum Generation Specifications (5L1503S only)

Symbol	Parameter	Description	Minimum	Typical	Maximum	Units
f_{OUT}	Output Frequency	Output frequency range.	1	—	100	MHz
f_{MOD}	Mod Frequency	Modulation frequency.	30 – 60			kHz
f_{SPREAD}	Spread Value	Amount of spread value (programmable)–down spread.	0.15% – 2.0%			% f_{OUT}

General I2C Interface Information

How to Write

- Controller (host) sends a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) sends the byte count = X
- IDT clock will acknowledge
- Controller (host) starts sending Byte N through Byte N+X-1
- IDT clock will acknowledge each byte one at a time
- Controller (host) sends a stop bit

Index Block Write Operation			
Controller (Host)			IDT (Slave/Receiver)
T	starT bit		
Slave Address			
WR	WRite		
			ACK
Beginning Byte = N			
			ACK
Data Byte Count = X			
			ACK
Beginning Byte N		X Byte	
			ACK
O			
O			O
O			O
			O
Byte N + X - 1			
			ACK
P	stoP bit		

How to Read

- Controller (host) will send a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- IDT clock will acknowledge
- IDT clock will send the data byte count = X
- IDT clock sends Byte N+X-1
- IDT clock sends Byte 0 through Byte X (if $X_{(H)}$ was written to Byte 8)
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

Index Block Read Operation			
Controller (Host)			IDT (Slave/Receiver)
T	starT bit		
Slave Address			
WR	WRite		
			ACK
Beginning Byte = N			
			ACK
RT	Repeat starT		
Slave Address			
RD	ReaD		
			ACK
			Data Byte Count=X
ACK			
		X Byte	Beginning Byte N
ACK			
			O
O			O
O			O
O			
			Byte N + X - 1
N	Not acknowledge		
P	stoP bit		

Byte 0: General Control

Byte 00h	Name	Control Function	Type	0	1	PWD
Bit 7	OTP_Burned	OTP memory programming indication	R/W	OTP memory non-programmed	OTP memory programmed	0
Bit 6	OTP TRIM	OTP memory programming indication	R/W	OTP TRIM bits non-programmed	OTP TRIM bits programmed	0
Bit 5	I2C_addr[1]	I2C address select bit 1	R/W	00: D0 / 01: D2 10: D4 / 11: D6		0
Bit 4	I2C_addr[0]	I2C address select bit 0	R/W			0
Bit 3	OTP TRIM Protect	OTP TRIM bits memory protection	R/W	read/write	write locked	0
Bit 2	OTP Configure Select 2	OTP Config Select Bit	R/W	Config 0	Config 1	0
Bit 1	OTP Configure Select <1>	DFC Config Select Bit 1	R/W	00: DFC Config 0 01: DFC Config 1 10: DFC Config 2 11: DFC Config 3		0
Bit 0	OTP Configure Select <0>	DFC Config Select Bit 0	R/W			0

Byte 1: Dash Code ID (optional)

Byte 01h	Name	Control Function	Type	0	1	PWD
Bit 7	XTAL_DIV2	XTAL Divider	R/W	Div /2	Bypass	0
Bit 6	DashCode ID[6]	Dash code ID	R/W	—	—	0
Bit 5	DashCode ID[5]	Dash code ID	R/W	—	—	0
Bit 4	DashCode ID[4]	Dash code ID	R/W	—	—	0
Bit 3	DashCode ID[3]	Dash code ID	R/W	—	—	0
Bit 2	DashCode ID[2]	Dash code ID	R/W	—	—	0
Bit 1	DashCode ID[1]	Dash code ID	R/W	—	—	0
Bit 0	DashCode ID[0]	Dash code ID	R/W	—	—	0

Byte 2: Crystal Cap Setting

Byte 02h	Name	Control Function	Type	0	1	PWD
Bit 7	Xtal_Cap[3]	Xtal cap load trimming bits	R/W	x1 x2 x4 x8 total 15pF		0
Bit 6	Xtal_Cap[2]	Xtal cap load trimming bits	R/W			0
Bit 5	Xtal_Cap[1]	Xtal cap load trimming bits	R/W			0
Bit 4	Xtal_Cap[0]	Xtal cap load trimming bits	R/W			1
Bit 3	PPS Hyst Prog	PPS Hysteresis Prog Bit1	R/W	00: 20mV 01: 40mV 10: 60mV 11: 80mV		0
Bit 2	PPS Hyst Prog	PPS Hysteresis Prog Bit0	R/W			0
Bit 1	PPS Vbias Prog	PPS Vbias Prog Bit 1	R/W	—	—	0
Bit 0	PPS Vbias Prog	PPS Vbias Prog Bit 0	R/W	—	—	0

Byte 3: OTP Protect

Byte 03h	Name	Control Function	Type	0	1	PWD
Bit 7	OTP Configure 3 Protect	—	R/W	read/write	write locked	0
Bit 6	OTP Configure 2 Protect	—	R/W	read/write	write locked	0
Bit 5	OTP Configure 1 Protect	—	R/W	read/write	write locked	0
Bit 4	OTP Configure 0 Protect	—	R/W	read/write	write locked	0
Bit 3	PPS2 Amp Prog	PPS OE2 Amplitude Prog Bit 1	R/W	00: 400mV 01: 500mV 10: 600mV 11: 700mV		0
Bit 2	PPS2 Amp Prog	PPS OE2 Amplitude Prog Bit 0	R/W			0
Bit 1	PPS1 Amp Prog	PPS OE1 Amplitude Prog Bit 1	R/W	00: 400mV 01: 500mV 10: 600mV 11: 700mV		0
Bit 0	PPS1 Amp Prog	PPS OE1 Amplitude Prog Bit 0	R/W			0

Byte 4: (Apply to 5L1503S)

Byte 04h	Name	Control Function	Type	0	1	PWD
Bit 7	UltraPowerDown	Ultra Power Down	R/W	disabled	enabled	0
Bit 6	EN DIFF CLKIN	Enable Differential Clkin on X1/X2	R/W	disabled	enabled	0
Bit 5	PLL HRS EN	-	R/W	normal	enable (shift 4 bits)	0
Bit 4	PLL EN 3rd	-	R/W	disabled	enabled	0
Bit 3	Reserved		R/W	—	—	0
Bit 2	PLL_FB_INT[10]	PLL feedback integer divider 10	R/W	—	—	0
Bit 1	PLL_FB_INT[9]	PLL feedback integer divider 9	R/W	—	—	0
Bit 0	PLL_FB_INT[8]	PLL feedback integer divider 8	R/W	—	—	0

Byte 4: (Apply to 5L1503/5L1503L)

Byte 04h	Name	Control Function	Type	0	1	PWD
Bit 7	UltraPowerDown	Ultra Power Down	R/W	disabled	enabled	0
Bit 6	EN DIFF CLKIN	Enable Differential Clkin on X1/X2	R/W	disabled	enabled	0
Bit 5	PLL HRS EN	—	R/W	normal	enable (shift 4 bits)	0
Bit 4	PLL EN 3rd	—	R/W	disabled	enabled	0
Bit 3	SEL_PREDIV	Divide by 4	R/W	disabled	enabled	0
Bit 2	PLL_FB_INT[10]	PLL feedback integer divider 10	R/W	—	—	0
Bit 1	PLL_FB_INT[9]	PLL feedback integer divider 9	R/W	—	—	0
Bit 0	PLL_FB_INT[8]	PLL feedback integer divider 8	R/W	—	—	0

Byte 5: PLL Integer Feedback Divider (Apply to 5L1503S)

Byte 05h	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_FB_INT_DIV[7]	PLL feedback integer divider 7	R/W	—	—	0
Bit 6	PLL_FB_INT_DIV[6]	PLL feedback integer divider 6	R/W	—	—	0
Bit 5	PLL_FB_INT_DIV[5]	PLL feedback integer divider 5	R/W	—	—	1
Bit 4	PLL_FB_INT_DIV[4]	PLL feedback integer divider 4	R/W	—	—	0
Bit 3	PLL_FB_INT_DIV[3]	PLL feedback integer divider 3	R/W	—	—	1
Bit 2	PLL_FB_INT_DIV[2]	PLL feedback integer divider 2	R/W	—	—	0
Bit 1	PLL_FB_INT_DIV[1]	PLL feedback integer divider 1	R/W	—	—	0
Bit 0	PLL_FB_INT_DIV[0]	PLL feedback integer divider 0	R/W	—	—	0

Byte 5: PLL Integer Feedback Divider (Apply to 5L1503/5L1503L)

Byte 05h	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_FB_INT_DIV[7]	PLL feedback integer divider 7	R/W	—	—	0
Bit 6	PLL_FB_INT_DIV[6]	PLL feedback integer divider 6	R/W	—	—	0
Bit 5	PLL_FB_INT_DIV[5]	PLL feedback integer divider 5	R/W	—	—	1
Bit 4	PLL_FB_INT_DIV[4]	PLL feedback integer divider 4	R/W	—	—	1
Bit 3	PLL_FB_INT_DIV[3]	PLL feedback integer divider 3	R/W	—	—	0
Bit 2	PLL_FB_INT_DIV[2]	PLL feedback integer divider 2	R/W	—	—	0
Bit 1	PLL_FB_INT_DIV[1]	PLL feedback integer divider 1	R/W	—	—	0
Bit 0	PLL_FB_INT_DIV[0]	PLL feedback integer divider 0	R/W	—	—	0

Byte 6: PLL Fractional Feedback Divider

Byte 06h	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_FB_FRC_DIV[15]	PLL feedback fractional divider 15	R/W	—	—	0
Bit 6	PLL_FB_FRC_DIV[14]	PLL feedback fractional divider 14	R/W	—	—	0
Bit 5	PLL_FB_FRC_DIV[13]	PLL feedback fractional divider 13	R/W	—	—	0
Bit 4	PLL_FB_FRC_DIV[12]	PLL feedback fractional divider 12	R/W	—	—	0
Bit 3	PLL_FB_FRC_DIV[11]	PLL feedback fractional divider 11	R/W	—	—	0
Bit 2	PLL_FB_FRC_DIV[10]	PLL feedback fractional divider 10	R/W	—	—	0
Bit 1	PLL_FB_FRC_DIV[9]	PLL feedback fractional divider 9	R/W	—	—	0
Bit 0	PLL_FB_FRC_DIV[8]	PLL feedback fractional divider 8	R/W	—	—	0

Byte 7: Fractional Feedback Divider

Byte 07h	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_FB_FRC_DIV[7]	PLL feedback fractional divider 7	R/W	—	—	0
Bit 6	PLL_FB_FRC_DIV[6]	PLL feedback fractional divider 6	R/W	—	—	0
Bit 5	PLL_FB_FRC_DIV[5]	PLL feedback fractional divider 5	R/W	—	—	0
Bit 4	PLL_FB_FRC_DIV[4]	PLL feedback fractional divider 4	R/W	—	—	0
Bit 3	PLL_FB_FRC_DIV[3]	PLL feedback fractional divider 3	R/W	—	—	0
Bit 2	PLL_FB_FRC_DIV[2]	PLL feedback fractional divider 2	R/W	—	—	0
Bit 1	PLL_FB_FRC_DIV[1]	PLL feedback fractional divider 1	R/W	—	—	0
Bit 0	PLL_FB_FRC_DIV[0]	PLL feedback fractional divider 0	R/W	—	—	0

Byte 8: PLL Spread Spectrum Control

Byte 08h	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_STEP[15]	PLL spread step size control bit 15	R/W	—	—	0
Bit 6	PLL_STEP[14]	PLL spread step size control bit 14	R/W	—	—	0
Bit 5	PLL_STEP[13]	PLL spread step size control bit 13	R/W	—	—	0
Bit 4	PLL_STEP[12]	PLL spread step size control bit 12	R/W	—	—	0
Bit 3	PLL_STEP[11]	PLL spread step size control bit 11	R/W	—	—	0
Bit 2	PLL_STEP[10]	PLL spread step size control bit 10	R/W	—	—	0
Bit 1	PLL_STEP[9]	PLL spread step size control bit 9	R/W	—	—	0
Bit 0	PLL_STEP[8]	PLL spread step size control bit 8	R/W	—	—	0

Byte 9: PLL Spread Spectrum Control

Byte 09h	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_STEP[7]	PLL spread step size control bit 7	R/W	—	—	0
Bit 6	PLL_STEP[6]	PLL spread step size control bit 6	R/W	—	—	0
Bit 5	PLL_STEP[5]	PLL spread step size control bit 5	R/W	—	—	0
Bit 4	PLL_STEP[4]	PLL spread step size control bit 4	R/W	—	—	0
Bit 3	PLL_STEP[3]	PLL spread step size control bit 3	R/W	—	—	0
Bit 2	PLL_STEP[2]	PLL spread step size control bit 2	R/W	—	—	0
Bit 1	PLL_STEP[1]	PLL spread step size control bit 1	R/W	—	—	0
Bit 0	PLL_STEP[0]	PLL spread step size control bit 0	R/W	—	—	0

Byte 10: PLL Period Control

Byte 0Ah	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_PERIOD[7]	PLL period control bit 7	R/W	—	—	0
Bit 6	PLL_PERIOD[6]	PLL period control bit 6	R/W	—	—	0
Bit 5	PLL_PERIOD[5]	PLL period control bit 5	R/W	—	—	0
Bit 4	PLL_PERIOD[4]	PLL period control bit 4	R/W	—	—	0
Bit 3	PLL_PERIOD[3]	PLL period control bit 3	R/W	—	—	0
Bit 2	PLL_PERIOD[2]	PLL period control bit 2	R/W	—	—	0
Bit 1	PLL_PERIOD[1]	PLL period control bit 1	R/W	—	—	0
Bit 0	PLL_PERIOD[0]	PLL period control bit 0	R/W	—	—	0

Byte 11: PLL M Divider Setting (Apply to 5L1503S)

Byte 0Bh	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_MDIV1	PLL reference divider 1	R/W	disable M DIV1	bypadd divider (/1)	1
Bit 6	PLL_MDIV2	PLL reference divider 2	R/W	disable M DIV2	bypadd divider (/2)	0
Bit 5	PLL_MDIV[5]	PLL reference divider control bit 5	R/W	3–63, default is 26		0
Bit 4	PLL_MDIV[4]	PLL reference divider control bit 4	R/W			1
Bit 3	PLL_MDIV[3]	PLL reference divider control bit 3	R/W			1
Bit 2	PLL_MDIV[2]	PLL reference divider control bit 2	R/W			0
Bit 1	PLL_MDIV[1]	PLL reference divider control bit 1	R/W			1
Bit 0	PLL_MDIV[0]	PLL reference divider control bit 0	R/W			0

Byte 11: PLL M Divider Setting (Apply to 5L1503/5L1503L)

Byte 0Bh	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_MDIV1	PLL reference divider 1	R/W	disable M DIV1	bypadd divider (/1)	0
Bit 6	PLL_MDIV2	PLL reference divider 2	R/W	disable M DIV2	bypadd divider (/2)	0
Bit 5	PLL_MDIV[5]	PLL reference divider control bit 5	R/W	3–63, default is 26		0
Bit 4	PLL_MDIV[4]	PLL reference divider control bit 4	R/W			1
Bit 3	PLL_MDIV[3]	PLL reference divider control bit 3	R/W			1
Bit 2	PLL_MDIV[2]	PLL reference divider control bit 2	R/W			0
Bit 1	PLL_MDIV[1]	PLL reference divider control bit 1	R/W			1
Bit 0	PLL_MDIV[0]	PLL reference divider control bit 0	R/W			0

Byte 12: PLL Loop R Setting (Apply to 5L1503S)

Byte 0Ch	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_MDIV_Doubler	PLL reference divider - doubler	R/W	disable	enable	0
Bit 6	PLL IREF	PLL CP reference current	R/W	1X	2X	1
Bit 5	PLL_SSEN	PLL spread spectrum enable	R/W	disable	enable	0
Bit 4	PLL_R100K	PLL Loop filter resister 100kOhm	R/W	bypass	plus 100Kohm	0
Bit 3	PLL_R50K	PLL Loop filter resister 50kOhm	R/W	bypass	plus 50Kohm	0
Bit 2	PLL_R25K	PLL Loop filter resister 25kOhm	R/W	bypass	plus 25Kohm	0
Bit 1	PLL_R12.5K	PLL Loop filter resister 12.5kOhm	R/W	bypass	plus 12.5Kohm	0
Bit 0	PLL_R1K	PLL Loop filter resister 1kOhm	R/W	bypass	only 1Kohm applied	1

Byte 12: PLL Loop R Setting (Apply to 5L1503/5L1503L)

Byte 0Ch	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_MDIV_Doubler	PLL reference divider - doubler	R/W	disable	enable	0
Bit 6	PLL IREF	PLL CP reference current	R/W	1X	2X	0
Bit 5	PLL_SSEN	PLL spread spectrum enable	R/W	disable	enable	0
Bit 4	PLL_R100K	PLL Loop filter resister 100kOhm	R/W	bypass	plus 100kOhm	0
Bit 3	PLL_R75K	PLL Loop filter resister 75kOhm	R/W	bypass	plus 75kOhm	0
Bit 2	PLL_R50K	PLL Loop filter resister 50kOhm	R/W	bypass	plus 50kOhm	0
Bit 1	PLL_R25K	PLL Loop filter resister 25kOhm	R/W	bypass	plus 25kOhm	1
Bit 0	PLL_R12.5K	PLL Loop filter resister 12.5kOhm	R/W	bypass	plus 12.5kOhm	1

Byte 13: PLL Charge Pump Control (Apply to 5L1503S)

Byte 0Dh	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_CP_31X	PLL charge pump control	R/W	—	x31	1
Bit 6	PLL_CP_16X	PLL charge pump control	R/W	—	x16	0
Bit 5	PLL_CP_8X	PLL charge pump control	R/W	—	x8	1
Bit 4	PLL_CP_4X	PLL charge pump control	R/W	—	x4	1
Bit 3	PLL_CP_2X	PLL charge pump control	R/W	—	x2	1
Bit 2	PLL_CP_1X	PLL charge pump control	R/W	—	x1	0
Bit 1	PLL_CP_/24	PLL charge pump control	R/W	—	/24	0
Bit 0	PLL_CP_/3	PLL charge pump control	R/W	—	/3	1

Byte 13: PLL Charge Pump Control (Apply to 5L1503/5L1503L)

Byte 0Dh	Name	Control Function	Type	0	1	PWD
Bit 7	PLL_CP_31X	PLL charge pump control	R/W	—	x31	0
Bit 6	PLL_CP_16X	PLL charge pump control	R/W	—	x16	0
Bit 5	PLL_CP_8X	PLL charge pump control	R/W	—	x8	0
Bit 4	PLL_CP_4X	PLL charge pump control	R/W	—	x4	1
Bit 3	PLL_CP_2X	PLL charge pump control	R/W	—	x2	0
Bit 2	PLL_CP_1X	PLL charge pump control	R/W	—	x1	1
Bit 1	PLL_CP_/24	PLL charge pump control	R/W	—	/24	1
Bit 0	PLL_CP_/3	PLL charge pump control	R/W	—	/3	0

Byte 14: Output Divider1 Control (Apply to 5L1503S)

Byte 0Eh	Name	Control Function	Type	0	1	PWD
Bit 7	OUTDIV1[4]	Output divider1 control bit 4	R/W	DIV1[3:2] = 1, 3, 5, 7, 9, 11; DIV1[1:0] = 1, 2, 4, 8; DefaultDivider=00001=3		0
Bit 6	OUTDIV1[3]	Output divider1 control bit 3	R/W			1
Bit 5	OUTDIV1[2]	Output divider1 control bit 2	R/W			0
Bit 4	OUTDIV1[1]	Output divider1 control bit 1	R/W			1
Bit 3	OUTDIV1[0]	Output divider1 control bit 0	R/W			0
Bit 2	OUTDIV2 Source Select	OUTDIV2 Source Select	R/W	From REF	OUTDIV2_Source	0
Bit 1	OUTDIV1 Source Select	OUTDIV1 Source Select	R/W	From REF	From PLL	1
Bit 0	OUTDIV1 Seed	OUTDIV1 Seed	R/W	disabled	enable seed to OUTDIV2	0

Byte 14: Output Divider1 Control (Apply to 5L1503/5L1503L)

Byte 0Eh	Name	Control Function	Type	0	1	PWD
Bit 7	OUTDIV1[4]	Output divider1 control bit 4	R/W	DIV1[3:2]=1,3,5,7,9,11; DIV1[1:0]=1,2,4,8; Default Divider = 00001=3		0
Bit 6	OUTDIV1[3]	Output divider1 control bit 3	R/W			0
Bit 5	OUTDIV1[2]	Output divider1 control bit 2	R/W			0
Bit 4	OUTDIV1[1]	Output divider1 control bit 1	R/W			0
Bit 3	OUTDIV1[0]	Output divider1 control bit 0	R/W			1
Bit 2	OUTDIV2 Source Select	OUTDIV2 Source Select	R/W	From REF	OUTDIV2_Source	0
Bit 1	OUTDIV1 Source Select	OUTDIV1 Source Select	R/W	From REF	From PLL	1
Bit 0	OUTDIV1 Seed	OUTDIV1 Seed	R/W	disabled	enable seed to OUTDIV2	0

Byte 15: Output Divider 2 Control

Byte 0Fh	Name	Control Function	Type	0	1	PWD
Bit 7	OUTDIV2[4]	Output divider2 control bit 4	R/W	DIV1[3:2]=1,3,5,7,9,11; DIV1[1:0]=1,2,4,8; Default Divider = 00001=3		0
Bit 6	OUTDIV2[3]	Output divider2 control bit 3	R/W			0
Bit 5	OUTDIV2[2]	Output divider2 control bit 2	R/W			0
Bit 4	OUTDIV2[1]	Output divider2 control bit 1	R/W			0
Bit 3	OUTDIV2[0]	Output divider2 control bit 0	R/W			1
Bit 2	OUT3_OUT_TRI	OUT3 State Select	R/W	normal	Tristate	0
Bit 1	OUT2_OUT_TRI	OUT2 State Select	R/W	normal	Tristate	0
Bit 0	OUT1_OUT_TRI	OUT1 State Select	R/W	normal	Tristate	0

Byte 16: PLL Operation Control Register

Byte 10h	Name	Control Function	Type	0	1	PWD
Bit 7	OUT1_EN	OUT1 output enable control	R/W	disable	enable	1
Bit 6	OE1_fun_sel[1]	OE1 pin function selection bit 1	R/W	11: DFC0 10: OUT1_PPS 01: PD# 00: OUT1 OE		0
Bit 5	OE1_fun_sel[0]	OE1 pin function selection bit 0	R/W			0
Bit 4	OUT2_EN	OUT2 output enable control	R/W	disable	enable	1
Bit 3	OE2_fun_sel[1]	OE2 pin function selection bit 1	R/W	11: DFC1 10: OUT2_PPS 01: Config_SEL 00: OUT2 OE		0
Bit 2	OE2_fun_sel[0]	OE2 pin function selection bit 0	R/W			0
Bit 1	OUT2 Freerun	OUT2 Freerun enable control	R/W	Freerun	normal	1
Bit 0	OUT1 Freerun	OUT1 Freerun enable control	R/W	Freerun	normal	0

Byte 17: OE and DFC Control

Byte 11h	Name	Control Function	Type	0	1	PWD
Bit 7	OUT1 CLKSEL 1	OUT1 output clock selection	R/W	00: CLK32K, 01: OUTDIV2 10: NA, 11: OUTDIV1		0
Bit 6	OUT1 CLKSEL 0	OUT1 output clock selection	R/W			0
Bit 5	OUT2 CLKSEL 1	OUT2 output clock selection	R/W	00: CLK32K, 01: OUTDIV2 10: NA, 11: OUTDIV1		1
Bit 4	OUT2 CLKSEL 0	OUT2 output clock selection	R/W			1
Bit 3	OUT3 CLKSEL 1	OUT3 output clock selection	R/W	00: CLK32K, 01: OUTDIV2 10: REF, 11: OUTDIV1		1
Bit 2	OUT3 CLKSEL 0	OUT3 output clock selection	R/W			0
Bit 1	OUT3_EN	OUT3 output enable control	R/W	disable	enable	1
Bit 0	DFC_EN	DFC function control	R/W	disable	enable	0

Byte 18: Control Register

Byte 12h	Name	Control Function	Type	0	1	PWD
Bit 7	PLL PDB	PLL Powerdown enable control	R/W	Powerdown	Not powerdown	1
Bit 6	PLL LOCKBYPASS	PLL Lock Bypass enable control	R/W	Bypass	Not Bypass	1
Bit 5	Reserved		R/W	—	—	0
Bit 4	PPS PDB EN	PPS PDB enable control	R/W	disable	enable	0
Bit 3	PPS2 Timer_sel<1>	PPS2 Timer select bit 1	R/W	00: 100µs 01: 200µs 10: 400µs 11: 800µs		0
Bit 2	PPS2 Timer_sel<0>	PPS2 Timer select bit 0	R/W			0
Bit 1	PPS1 Timer_sel<1>	PPS1 Timer select bit 1	R/W	00: 100µs 01: 200µs 10: 400µs 11: 800µs		0
Bit 0	PPS1 Timer_sel<0>	PPS1 Timer select bit 0	R/W			0

Byte 19: Control Register

Byte 13h	Name	Control Function	Type	0	1	PWD
Bit 7	OUT1 CLK Invert	OUT1 CLK Invert control	R/W	Non-Invert	Invert	0
Bit 6	OUT2 CLK Invert	OUT2 CLK Invert control	R/W	Non-Invert	Invert	0
Bit 5	OUT3 CLK Invert	OUT3 CLK Invert control	R/W	Non-Invert	Invert	0
Bit 4	OUT3 Freerun	OUT3 Freerun enable control	R/W	Freerun	normal	1
Bit 3	OUT2 Amp OUT 1	OUT2 Amplitude Select control	R/W	00: 1.8V 01: 1.0V 10: 1.1V 11: 1.0V		0
Bit 2	OUT2 Amp OUT 0	OUT2 Amplitude Select control	R/W			0
Bit 1	OUT3 Amp OUT 1	OUT3 Amplitude Select control	R/W	00: 1.8V 01: 1.0V 10: 1.1V 11: 1.0V		0
Bit 0	OUT3 Amp OUT 0	OUT3 Amplitude Select control	R/W			0

Byte 20: OUT1 and DIV4 Control (Apply to 5L1503/5L1503S)

Byte 14h	Name	Control Function	Type	0	1	PWD
Bit 7	I2C_PDB	chip power down control bit	R/W	power down	normal	1
Bit 6	Ref_free_run	Reference clock output (OUT2/OUT3)	R/W	stop	freerun	0
Bit 5	free_run_output_config	OUT clocks free run control	R/W	OUT2 free run	OUT2/3 free run	0
Bit 4	PDB Invert	PDB polarity control bit	R/W	Non-Invert	Invert	0
Bit 3	BYP_AC	Bypass AC cap in X1 (5L1503 only)	R/W	normal	Bypass	0
Bit 2	Reserved		R/W	—	—	0
Bit 1	Reserved		R/W	—	—	1
Bit 0	Reserved		R/W	—	—	1

Byte 20: OUT1 and DIV4 Control (Apply to 5L1503L)

Byte 14h	Name	Control Function	Type	0	1	PWD
Bit 7	I2C_PDB	chip power down control bit	R/W	power down	normal	1
Bit 6	Ref_free_run	Reference clock output (OUT2/OUT3)	R/W	stop	freerun	0
Bit 5	free_run_output_config	OUT clocks free run control	R/W	OUT2 free run	OUT2/3 free run	0
Bit 4	PDB Invert	PDB polarity control bit	R/W	Non-Invert	Invert	0
Bit 3	BYP_AC	Bypass AC cap in X1	R/W	normal	Bypass	0
Bit 2	CLK32K Low Drive Amp Select<2:0>	CLK32K Low Drive Amplitude Select<2:0>	R/W	000: 1.8V 001: 0.8V 010: 0.9V 011: 1.0V 100: 1.1V 101:1.2V		0
Bit 1			R/W			1
Bit 0			R/W			1

Glossary of Features

Table 18. Glossary of Features

Term	Function Description	Apply to
DFC	Dynamic Frequency Control from selected PLL to support two VCO frequencies–two different output frequencies by assigning H/W pin state changes (H-L or L-H). Needs to have frequency change glitch-free function in order to not crash application system.	All
ORT	Overshoot Reduction Technology–when the PLL performs VCO frequency changes by DFC, or manually programming, the VCO changes frequencies smoothly to target frequency without overshoot or undershoot.	All
OE	Output Enable function. High active. Each output can be controlled by assigned OE pin and the dedicated OE pin can be OTP programmable as Global Power Down function (PD#) or Output enable (OE) or proactive power saving function (PPS).	All
PCT	Programmable Calibration Time, for 32K DCO, the programmable calibration time will help power saving or output accuracy adjustments.	All
Glitch-free	The output clock should not have short pulses that will kill the application system, the output frequency switch (based on DFC) should has glitch-free function.	All
SS	Spread Spectrum Clock	5L1503S
PPS	Proactive Power Saving. Utilizes OE pin as monitor pin for end device X2 clock status. See PPS – Proactive Power Saving Function description for details.	All

Package Outline Drawings

The package outline drawings are appended at the end of this document and are accessible from the link below. The package information is the most current data available.

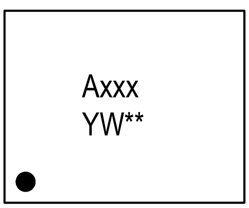
www.idt.com/document/psc/10-vfqfpn-package-outline-drawing-20-x-20-x-055-mm-body-04mm-pitch-nvg10p1

Ordering Information

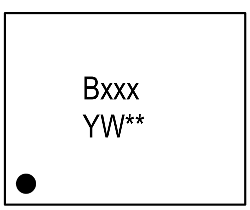
Orderable Part Number	Package	Shipping Packaging	Temperature
5L1503-xxxNVGI	2.0 × 2.0 × 0.55 mm 10-VFQFPN	Tray	-40° to +85°C
5L1503-xxxNVGI8	2.0 × 2.0 × 0.55 mm 10-VFQFPN	Reel	-40° to +85°C
5L1503-xxxNVGI	2.0 × 2.0 × 0.55 mm 10-VFQFPN	Tray	-40° to +85°C
5L1503-xxxNVGI8	2.0 × 2.0 × 0.55 mm 10-VFQFPN	Reel	-40° to +85°C
5L1503-xxxNVGI	2.0 × 2.0 × 0.55 mm 10-VFQFPN	Tray	-40° to +85°C
5L1503-xxxNVGI8	2.0 × 2.0 × 0.55 mm 10-VFQFPN	Reel	-40° to +85°C

Marking Diagrams

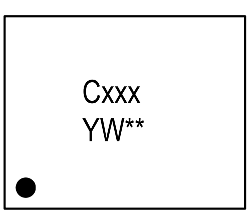
5L1503



5L1503L



5L1503S



- Line 1 is the truncated part number and indicates the following:
  - “A” denotes 5L1503; “xxx” denotes dash code.
  - “B” denotes 5L1503L; “xxx” denotes dash code.
  - “C” denotes 5L1503S; “xxx” denotes dash code.
- Line 2 indicates the following:
  - “YW” is the last digit of the year and work week the part was assembled.
  - “**” denotes sequential lot number.

Revision History

Revision Date	Description of Change
June 19, 2019	Initial release.

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